

Low Radioactivity Materials

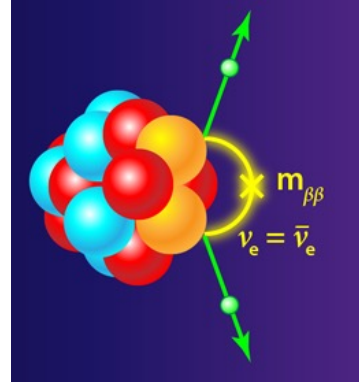
Richard Saldanha
12th November 2025
Montreal, Canada



Pacific Northwest
NATIONAL LABORATORY



NLDBD Signal



$$\text{Decay Rate} = \left| \frac{dN}{dt} \right| = \frac{N}{\tau} \quad \begin{array}{l} N = \text{Number of isotope atoms} \\ \tau = \text{Decay mean life} \end{array}$$

For ^{136}Xe at the goal of the next generation experiments
($T_{1/2} \sim 10^{28}$ yrs)

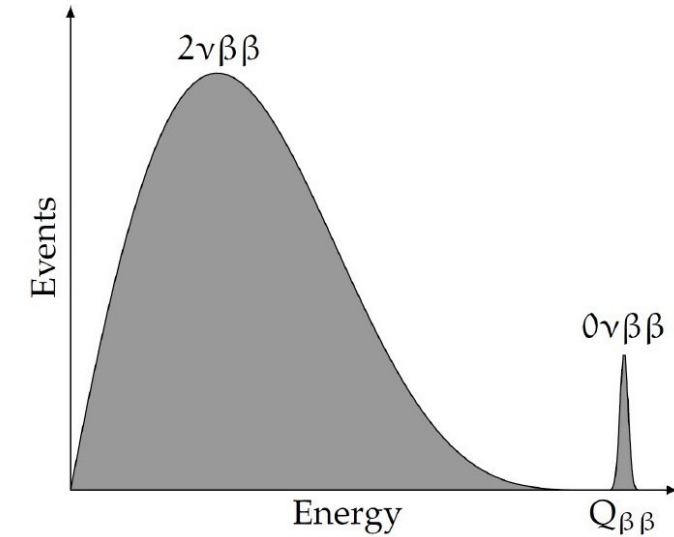
Specific Decay Rate ~ 0.3 events / ton / yr
 ~ 10 pBq/kg

Natural soil is ~ 10 Bq/kg

Central Challenge for all Experiments: Need ultra-low radioactivity material

Backgrounds to ^{136}Xe NLDBD

- Q_{bb} for ^{136}Xe : **2458 keV**
Above most, but not all, natural radioactive background emissions
- Most Dangerous Radioactive Backgrounds
 - ^{214}Bi :
 - Progeny of ^{238}U , below ^{222}Rn
 - 1.5% gamma emission at 2448 keV (0.4% separation from Q_{bb})
 - Decays in passive material cannot be tagged
 - ^{208}Tl
 - Progeny of ^{232}Th (36% BR)
 - Gamma emission at 2615 keV, Compton edge: 2382 keV
 - ^{137}Xe
 - Formed by neutron capture on $\text{Xe}136$, Half-life: 3.8 min
 - Beta decay with $Q_b = 4173$ keV
 - ^{60}Co
 - Typically an activation product
 - 2E-6% Gamma emission at 2506 keV, or combination of 1173 and 1333 keV gammas



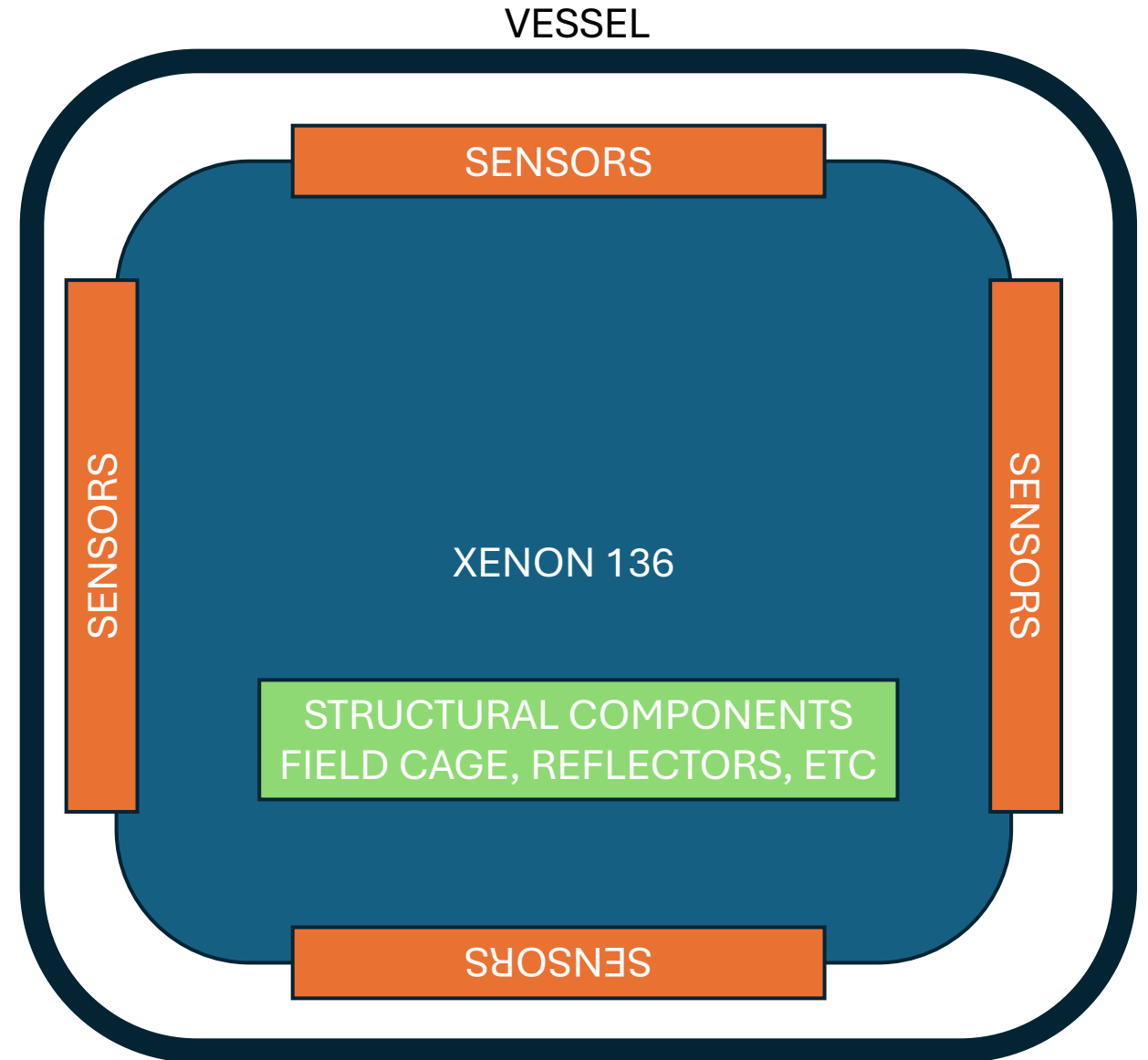
Generic Xenon Detector

What materials can we use to build a NLDBD Xe detector?

Focus on bulk intrinsic radiocontamination

Not covered here:

- Radon emanation
- Cosmogenic activation
- Surface backgrounds
- Cleaning procedures



Radiopure Vessels (for Pressure)

Materials used for pressure vessel need to have high yield strength.

Two materials typically used

Stainless Steel

Most commonly available material
 Best radiopurity found in austenitic 1.4571 material [GERDA]

Titanium

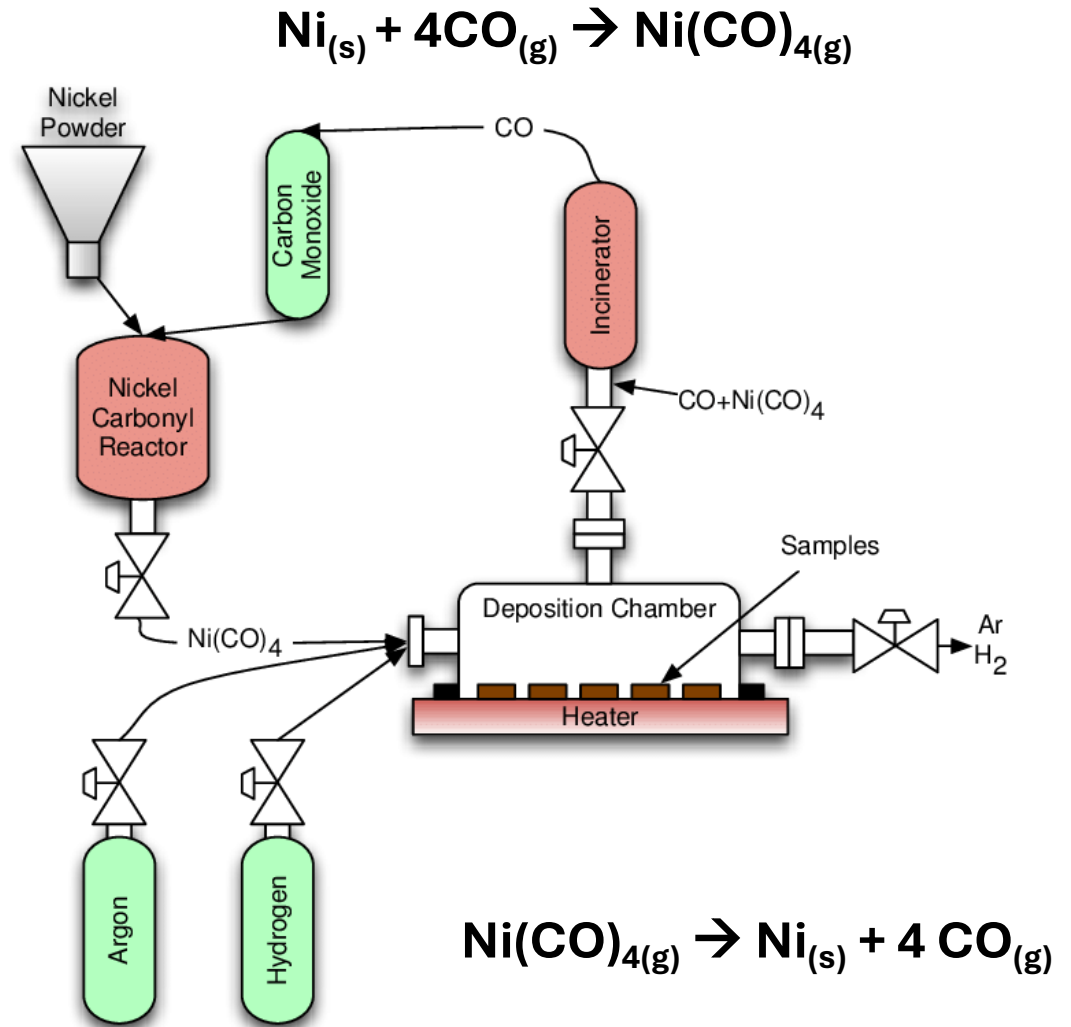
High strength-to-weight ratio
 Lower Z, fewer activation products
 Best radiopurity found in ASTM Grade 1 titanium with 0% scrap, produced with electron beam cold hearth (EBCH) re-melting [LZ]

Experiment	Type	Mass (kg)	^{238}U (mBq/kg)	^{232}Th (mBq/kg)	^{60}Co (mBq/kg)	^{40}K (mBq/kg)	^{46}Sc (mBq/kg)
DarkSide50 [29]	SS	175	< 1	< 1	13.1 ± 1	–	–
XENON100 [27]	SS	74	< 1.8	< 0.03	5.4 ± 0.5	< 9	–
XENON1T [30]	SS	870	2.4 ± 0.7	0.21 ± 0.06	< 0.36	9.7 ± 0.8	2.7
XENONnT.	SS		0.3 +/- 1	0.6 +/- 0.2	2.4 +/- 2	1.6 +/- 0.6	
PandaX-II	SS		< 1.9	< 3.0	< 0.7	< 16	
NEXT	SS		< 0.46	< 0.69	4.4 +/- 0.3	< 1.0	
LUX [11]	Ti	230	< 0.25	< 0.2	–	< 1.2	2.5
LZ (this work)	Ti	1,827	$\text{U}_e < 1.6$ $\text{U}_l < 0.09$	$\text{Th}_e: 0.28 \pm 0.03$ $\text{Th}_l: 0.23 \pm 0.02$	< 0.02	< 0.54	2.0 ± 0.1

Chemical Vapor Deposition (CVD)

- Start with element you want to deposit
- Create reactant gaseous compound
- Decompose that gas mixture over a heated substrate to leave behind the atoms of interest

Both the formation of the gaseous compound and decomposition on the substrate depend on the chemistry and thermodynamics of the process, allowing for deposition of extremely high purity materials



Generalized schematic of Mond, or carbonyl, process used by CVMR (Muralidharan et al., 2011)

CVD Nickel

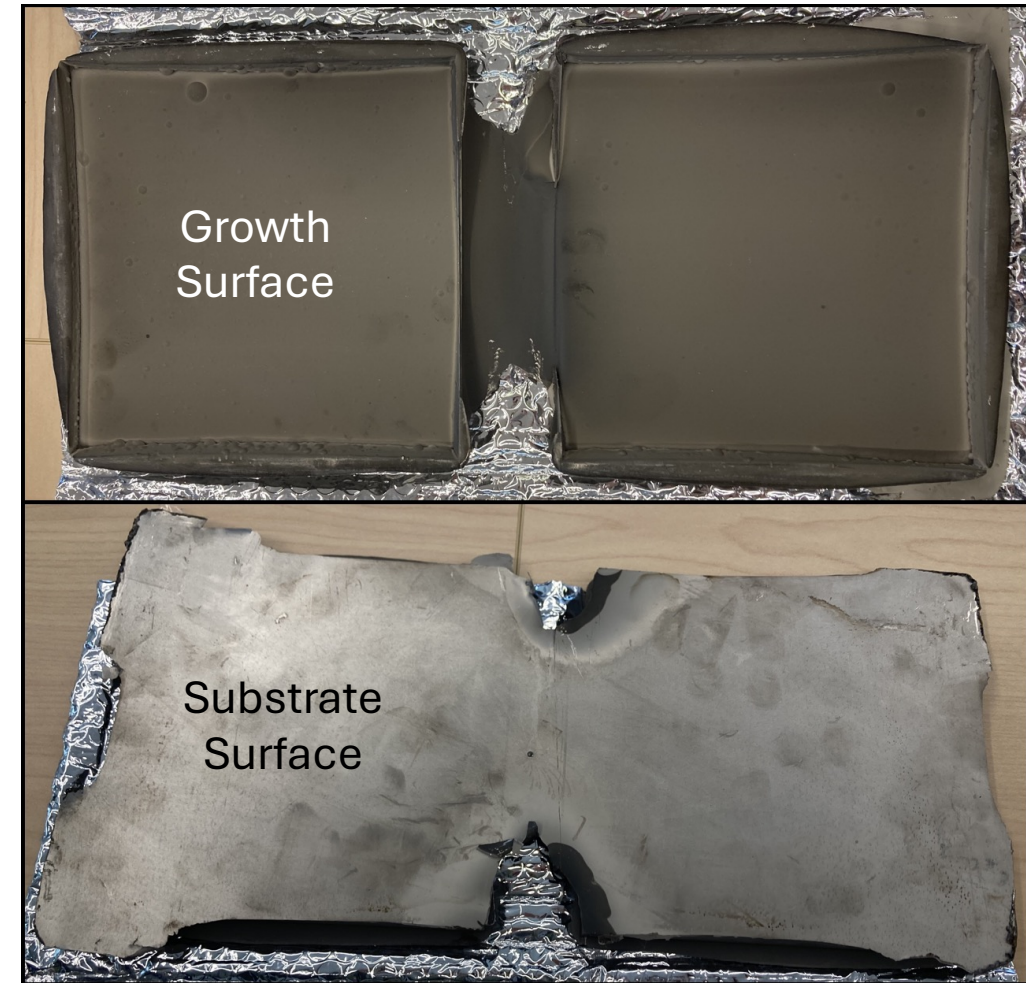


CVD Nickel produced by CVMR was used for the SNO ^3He proportional counter tubes

Produced through the MOND process with nickel carbonyl (extremely hazardous)

Recently explored by nEXO for cryostat vessel
arXiv:2508.08230 [nucl-ex]

Deposition rates can be as fast as 0.75 mm/hr,
with achievable thickness over 5 cm



Material	238U [uBq/kg]	232Th [uBq/kg]	40K [uBq/kg]	Yield Strength [MPa]
SS (XENONnT)	300 +/- 100	600 +/- 200	1600 +/- 600	200-240
Titanium (LZ)	< 90	230 +/- 20	< 540	170-310
CVD Nickel	< 1.2*	~0.3*	~30	~400**

*Bulk contamination determined by ICP-MS (top of the chain)

** Unwelded, Property Characterization of CVD Nickel, Masters Thesis, Patrice Bansa, University of Toronto

CVD Nickel

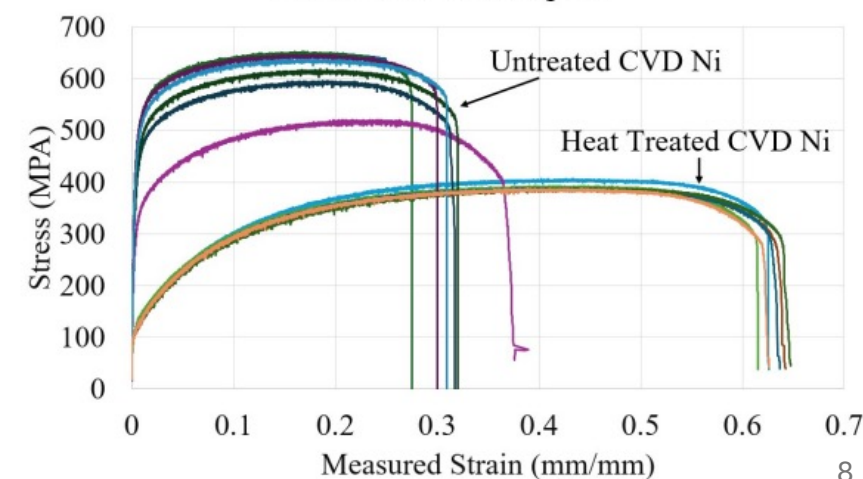
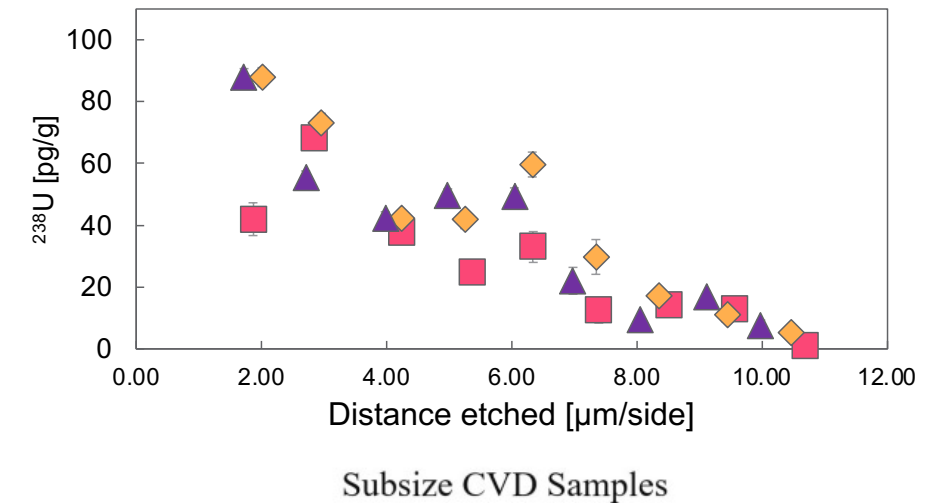
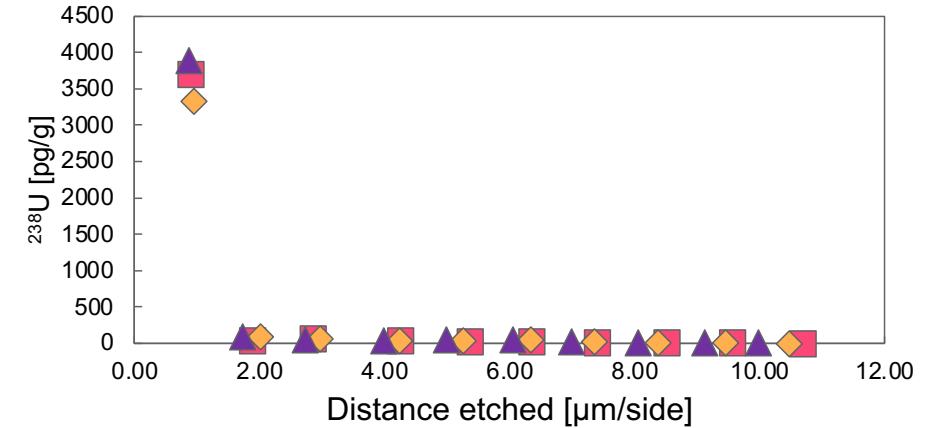
Investigations into CVD Nickel still in early stage

– lots to explore

- Surface contamination detected, likely from Al substrate (other substrates are possible)
- Does secular equilibrium hold?
- CVD Ni is stronger than conventional nickel, but loses strength when heat treated – impact on welded pressure vessels?
- Can be grown quickly, but production scale limited by available chambers
- Expensive compared to SS and Ti

Ultra-pure Nickel for Structural Components of Low-Radioactivity Instruments

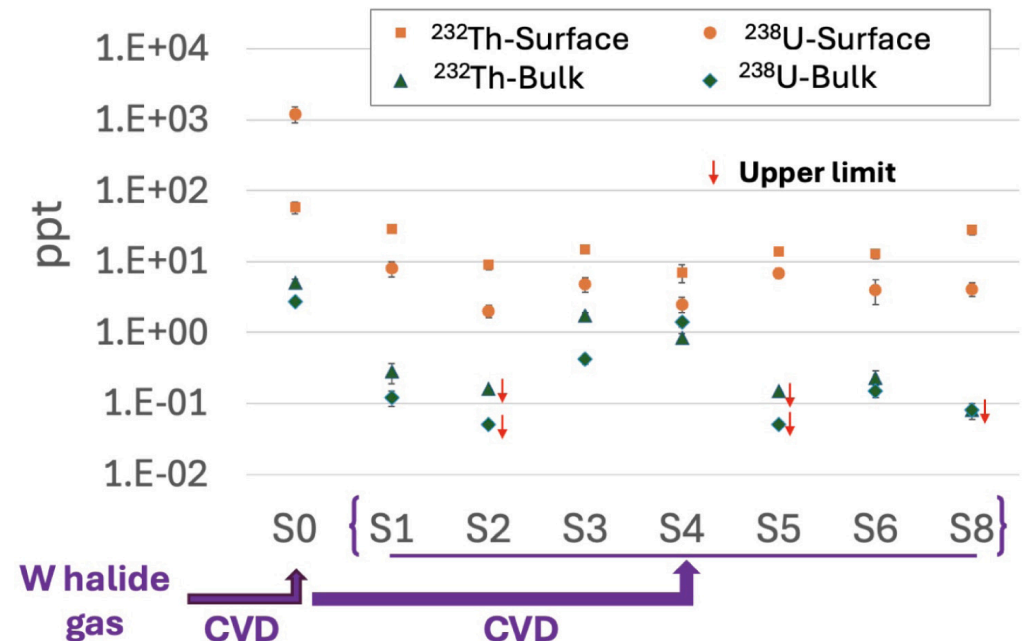
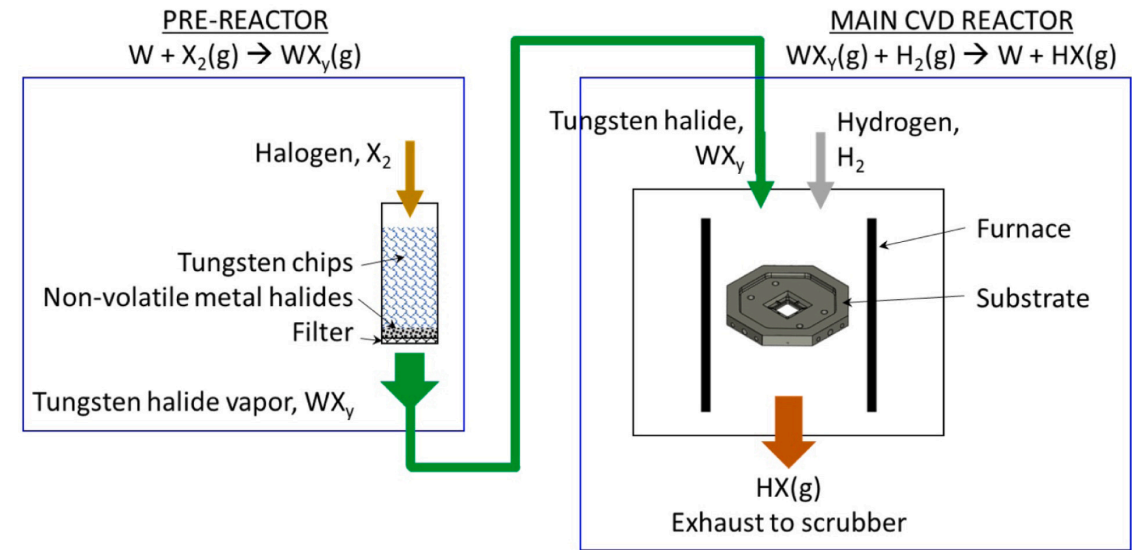
arXiv:2508.08230



Other CVD materials

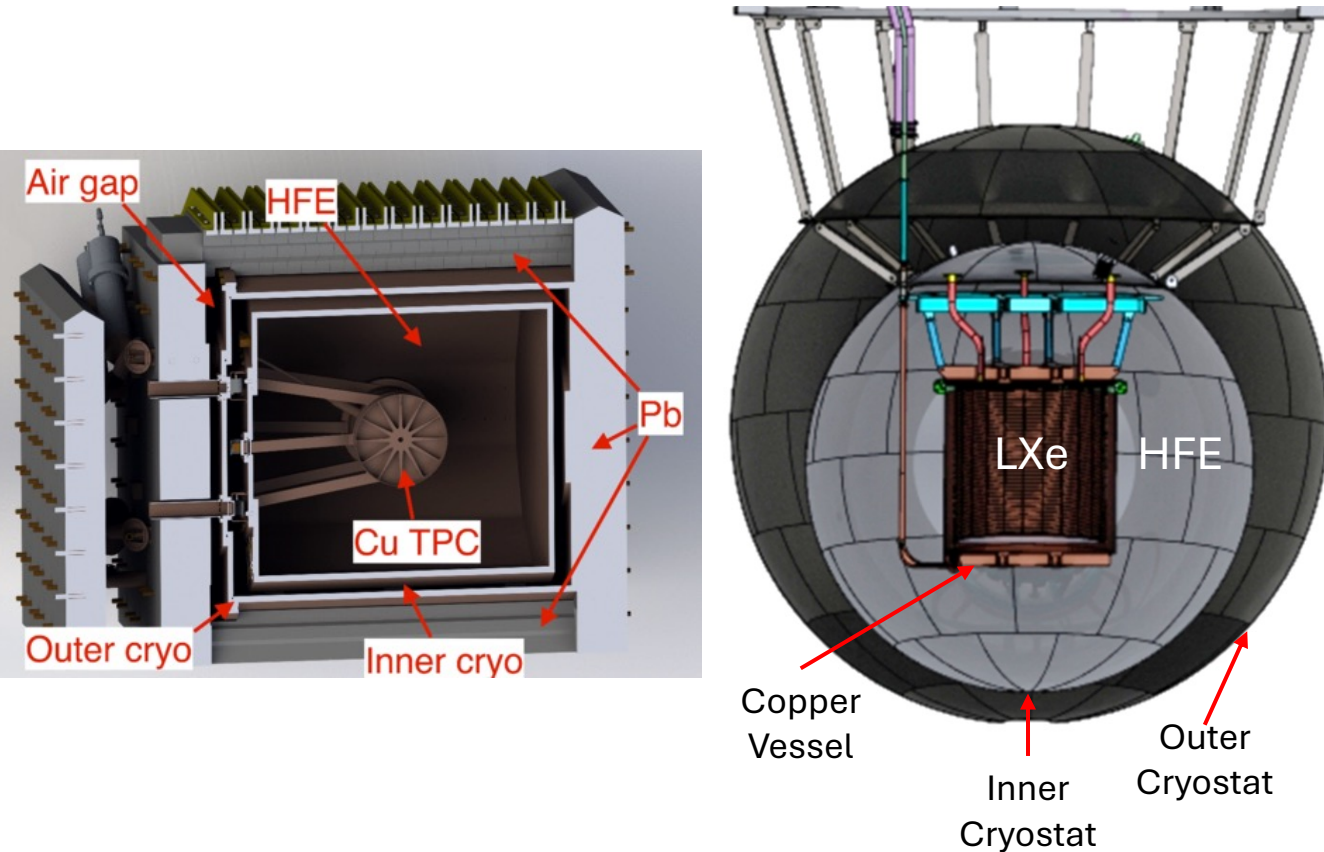
- PNNL staff recently worked with Ultramet through an SBIR grant to develop **CVD tungsten** with radiopurity levels at **~ 1 uBq/kg U and Th**
- Currently limited to 1-2 mm thick at Ultramet
- High density of tungsten (19.3 g/cm^3 , 1.7x denser than lead) makes it attractive for shielding
- Details can be found in:
High-purity tungsten produced via chemical vapor deposition for use in low-background detectors
 NIM A 1082 (2026) 171018

CVD can also be used for other materials such as tantalum....



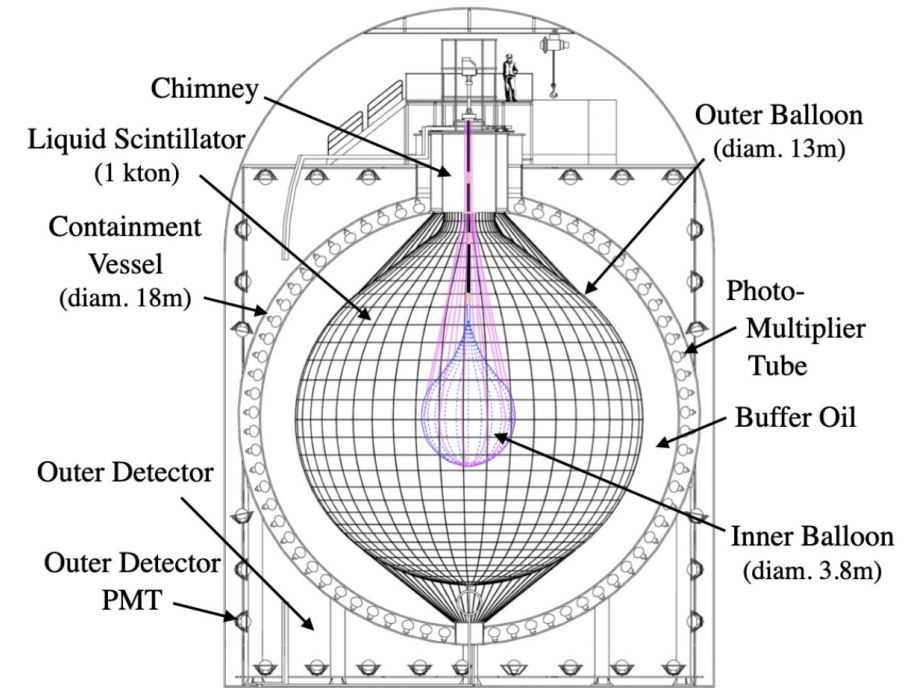
Vessels – Low Pressure

Copper



EXO-200, nEXO design have a thin (few-mm) copper vessel with a refrigerant (HFE) balancing the pressure on the outside

Nylon



2021 JINST 16 P08023

Figure 1. Schematic view of KamLAND with the IB for KamLAND-Zen 800.

KamLAND-Zen use a thin (25 μm) nylon vessel to separate the loaded scintillator from standard LS

Electroformed Copper

- Electroforming takes advantage of the relatively high reduction potential of copper compared to most radioisotopes to produce copper with very high purity.
- Reduction potential is not the only consideration (otherwise all electroplated copper would have negligible U & Th), mass transport and other factors play a critical role
- By carefully setting the electroplating voltages and bath parameters, PNNL chemists have developed custom **electroformed copper (EFCu)** that has been demonstrated to have > 25x lower radiocontamination than even the cleanest commercial copper

Reductants		Oxidants	E^0 (V)
$\text{Cu}^{2+} + 2e^-$	\rightleftharpoons	Cu	+0.34
$\text{Pb}^{2+} + 2e^-$	\rightleftharpoons	Pb	-0.13
$\text{U}^{3+} + 3e^-$	\rightleftharpoons	U	-1.80
$\text{Th}^{4+} + 4e^-$	\rightleftharpoons	Th	-1.90
$\text{K}^+ + e^-$	\rightleftharpoons	K	-2.93

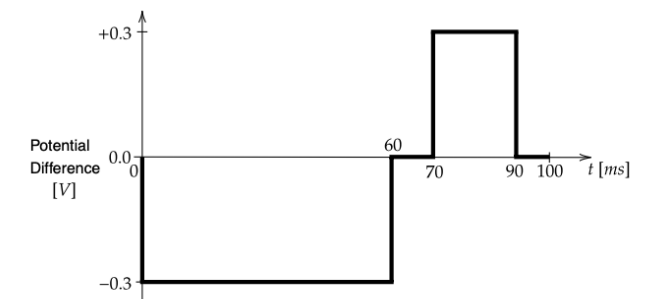
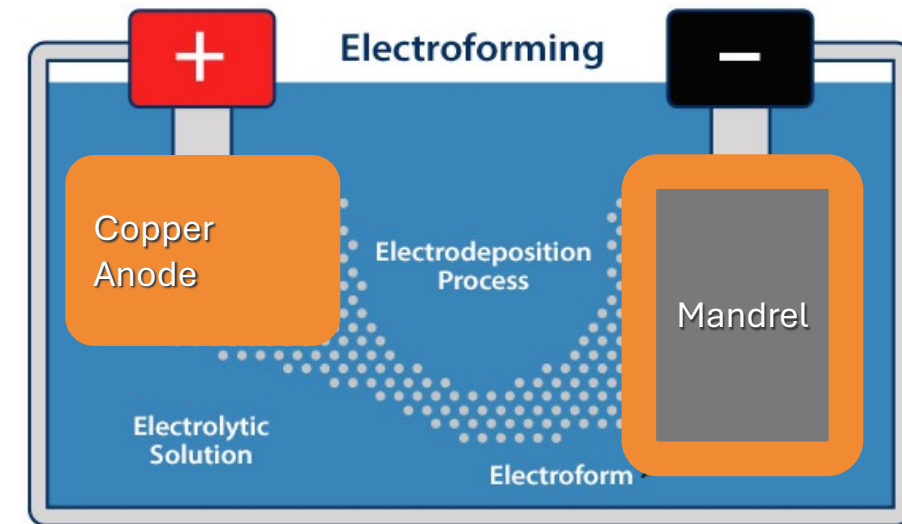


Figure 5: Waveform used in the electroplating. The negative terminal was attached to the cathode.

Electroformed Copper

- Electroformed copper can be made in different shapes and forms
- Used by several low-background experiments
- Radiopurity values limited by assay sensitivity



1" diameter gas proportional counters



13" diameter cylinder
PNNL Shallow Underground Lab

Material	^{238}U [uBq/kg]	^{232}Th [uBq/kg]	^{40}K [uBq/kg]	Tensile Strength [MPa]
SS (XENONnT)	300 +/- 100	600 +/- 200	1600 +/- 600	200-240
Titanium (LZ)	< 90	230 +/- 20	< 540	170-310
CVD Nickel	< 1.2*	~0.3*	~30	~400**
Aurubis Copper	3.1	0.53	< 28	~33 (annealed)
EFCu	< 0.12	< 0.04	< 68	~60



Electroforming baths, SURF

- Limited by growth rate of ~ 1 mm/month. Expensive

Electroformed Copper R&D

Reducing Cost

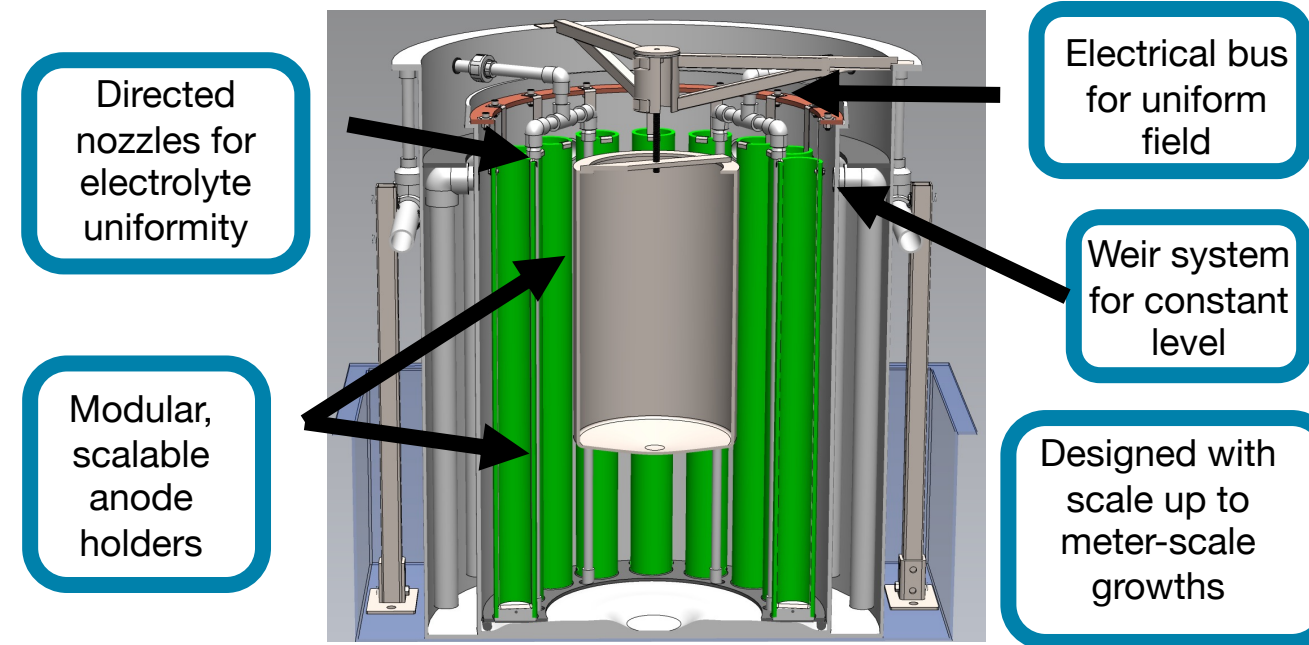
- ~40% of EFCu fabrication cost is due to highest purity acid
- Initial R&D results indicate that lower grade acid (10x cheaper) does not limit purity
- Publication in progress

Developing high-purity, high-strength copper-based alloys

- Investigating Cu-Cr alloy manufacturing via co-plating
 - Other potential alloys Ni, Ag, Zr
- Improve strength, reduce fabrication time and costs

Increasing Scale

- Redesign electroplating bath to enable meter-scale vessels



External Fluid

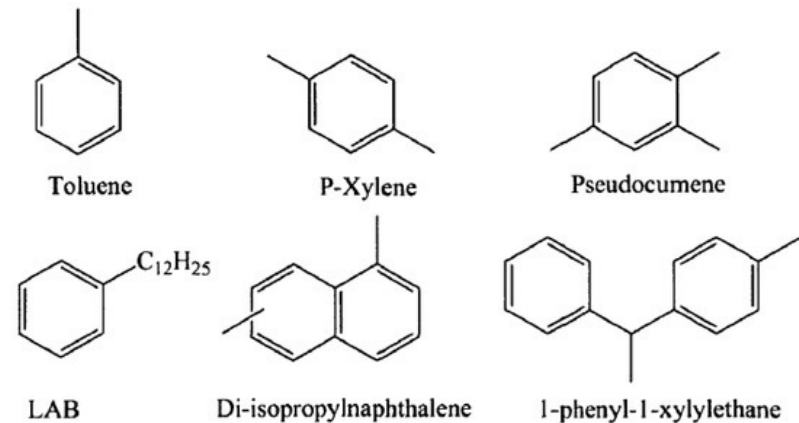
- **HFE-7000**

- 3M Novec 7000 Engineered heat transfer fluid (1-methoxyheptafluoropropane)
- Liquid at both room temperature and LXe temperature
- Extremely radiopure **^{238}U : 42 +/- 6 nBq/kg, ^{232}Th : < 3 nBq/kg**



- **Organic Liquid scintillator**

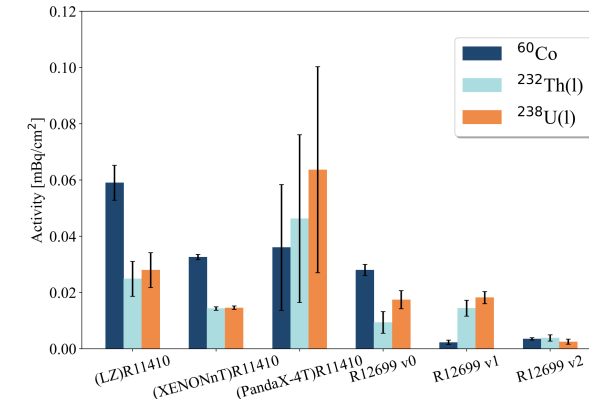
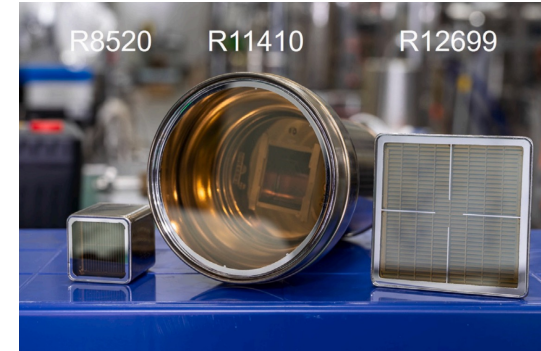
- Many options:
- Extremely radiopure
 - KamLAND **^{238}U : 61 +/- 2 pBq/kg; ^{232}Th : 53 +/- 4 pBq/kg**
 - Borexino: **^{238}U : < 1 pBq/kg; ^{232}Th : < 4 pBq/kg**
 - ^{210}Po out of equilibrium



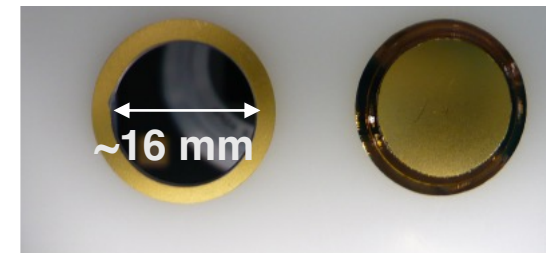
Photosensors

Custom development of VUV, in-LXe PMTs has led to significant improvements in radiopurity

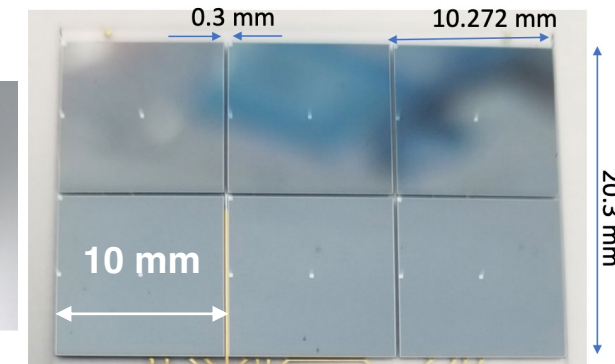
Silicon-based sensors (especially VUV-sensitive **SiPMs**) are still *orders of magnitude* less radioactive.



[Hamamatsu Xe PMTs NIM A 1073 \(2025\): 170290](#)



Advanced Photonix LAAPD
(NIM A 608, 68 [2009])



HPK 1 cm² VUV-sensitive SiPMs
(nEXO)

TYPE	Model	Activity [$\mu\text{Bq}/\text{cm}^2$]			
		^{238}U	^{232}Th	40K	^{60}Co
PMT	R11410-10 (LZ)	28 (6)	25 (6)	380 (30)	59 (6)
PMT	R11410-20 (XENONnT)	15 (2)	14 (1)	440 (20)	33 (1)
PMT	R11410-23 (PandaX-4T)	< 120	< 95	< 690	< 73
PMT	R13111 (XMASS)	11 (2)	4 (1)	52 (13)	3 (1)
PMT	R12699-406-M4 (v2)	3 (1)	-	1500 (100)	4 (1)
LAAPD	API SD630-70-75-500 (EXO-200)	< 0.1	< 0.1		
SiPM	63XFBK VUV-HD (nEXO)	0.00068 (4)	0.00012 (3)		

Electronics

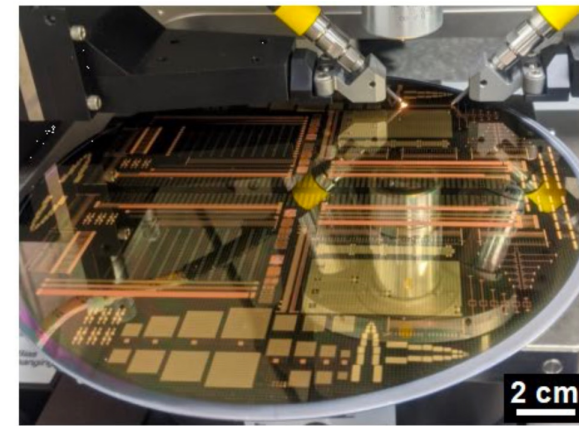
- **Silicon** is very clean (eg. ASICs)
 - Circuit substrates
 - **NOT FR4 or G10**
 - **Silicon, Fused Silica** are extremely radiopure options
- Development of a Silicon Interposer: Toward an Ultralow Radioactivity Background Photodetector System IEEE TRANS. ON NUCLEAR SCIENCE, VOL. 70, NO. 2, 2023*

Cirlex: Commercial Kapton is not very clean - typically 1000 ppt ^{238}U

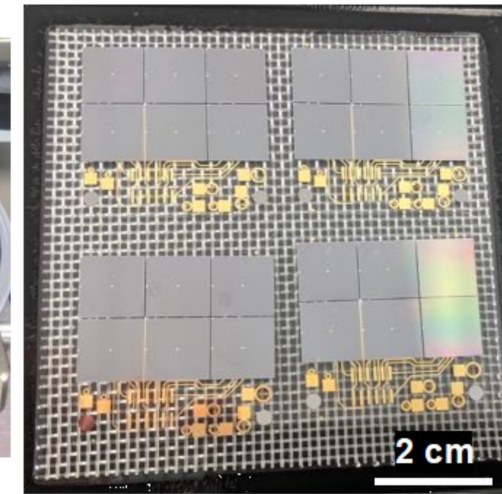
Collaboration with DuPont and study of the manufacturing process led us to identify the dominant source of contamination in Kapton material: DCP a slip additive used to improve processing yield

Special production of DCP-less Kapton and Kapton-copper laminates showed ~20x reduction in radiocontamination

Ultra-low radioactivity Kapton and copper-Kapton laminates
NIM A 959 (2020): 163573



Wafer with test structures for silicon interposer development, fabricated by Fraunhofer IZM



Double-sided fused silica tiles with through fused silica vias (TFVs) and 1 cm² SiPMs mounted in a 3x2 array. Four tiles are shown, with wiring layers visible in gold and test structures at the bottom (the fused silica substrates are transparent)

	^{238}U [pg/g]	^{232}Th [pg/g]	natK [ng/g]
Commercial Kapton HN	1080 +/- 40	250 +/- 8	44 +/- 18
R&D Kapton	12.3 +/- 1.9	19 +/- 2	34 +/- 14
Commercial Kapton-Cu Laminate	158 +/- 6	24.1 +/- 0.9	< 210
R&D Kapton-Cu Laminate	9 +/- 4	20 +/- 14	160 +/- 80

Electronics

Capacitors and Resistors

- **Ceramics** are typically not very radiopure
- **Silicon**-based components are now available, but can be expensive
- Thin film components seem to be better?

Custom Development

High voltage capacitors for low background experiments, Eur. Phys. J. C (2013) 73:2445

Small Business Innovation Research (SBIR)

“Radiopure electronic components ... for reading out sensors for neutrinoless double beta decay detectors and possibly quantum sensors. Of specific interest are capacitors, resonators, circuit substrates, connectors, and cables. The desired radioactivity of these components is **typically < 100 parts-per-trillion ^{238}U & ^{232}Th (< 1 mBq/kg)**, though the exact requirements depend on the mass and location of the component with respect to the sensitive volumes of the experiment.”



Radiopure Cables

Worked with commercial company (through SBIR grant) to investigate radioactive contamination in each individual fabrication step

Developed new radiopure fabrication process that resulted in 5-100x reduction in U/Th/K contamination

Cable	Copper layers [μm]	Polyimide layers [μm]	Coverlay	Surface finish	²³⁸ U [pg/g]	²³² Th [pg/g]	natK [ng/g]
nEXO SiPM	18 (x2)	50.8 (x1)	No	No	20 ± 2	<12.3	40 ± 12
nEXO SiPM [Com.]	18 (x2)	50.8 (x1)	No	No	1300-6200	16-63	
DAMIC-M CCD	18 (x2)	50.8 (x1)	x2	ENIG	31 ± 2	13 ± 3	550 ± 20
DAMIC-M CCD [Com.]	18 (x2)	50.8 (x1)	x2	ENIG	2600 ± 40	261 ± 12	170 ± 50
EXO-200 [3, 12]	18 (x1)	25.4 (x1)	No	No	412 ± 47	<117	
EDELWEISS III [7, 14]	18 (x4)	25/125 (x3/x4)	No	No	650 ± 490	3700 ± 2500	2100 ± 840
DAMIC at SNOLAB [4]	18 (x5)	25.4 (x4)	x2	ENIG	4700 ± 400	790 ± 120	940 ± 60

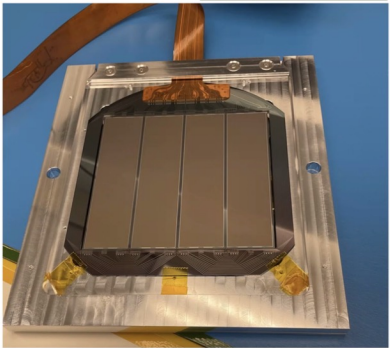
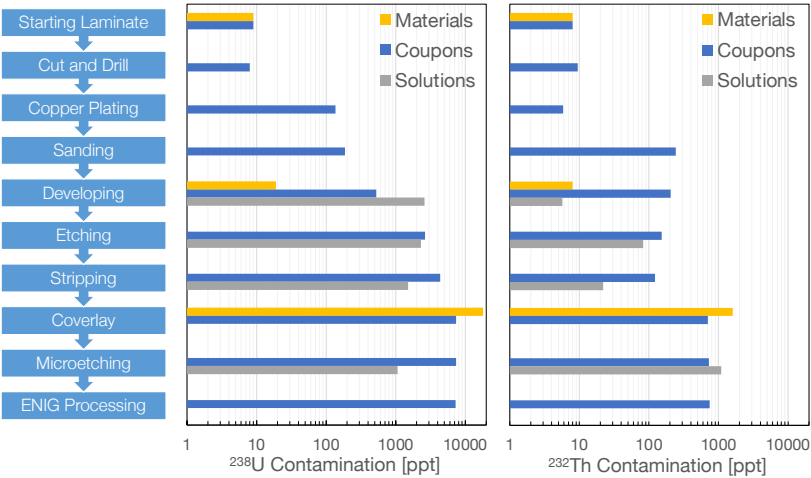
Have manufactured radiopure cables for SiPMs and CCDs

Just received a SBIR Phase IIB grant to develop radiopure controlled-impedance stripline cables



Ultra-low radioactivity flexible printed cables

Isaac J. Arnquist¹, Maria Laura di Vacri¹, Nicole Rocco¹, Richard Saldanha^{1*}, Tyler Schlieder¹, Raj Patel², Jay Patil², Mario Perez² and Harshad Uka²

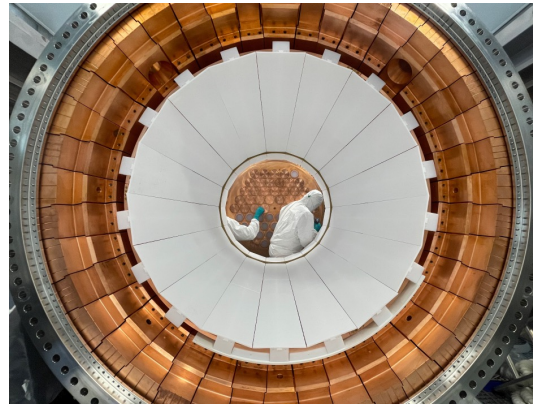


Delivered **28x 1.5-meter-long** flexible cables that met the radiopurity requirements for DAMIC-M. **10x** reduction compared to off-the-shelf options
Now only ~3% of DAMIC-M background budget ¹⁸

Reflectors

PTFE

- > 95% (> 90%) reflectivity at LXe (visible) wavelengths
- Need ~ 1(5) mm thickness at 175 nm (420 nm)
- Radiopurity very good



Al + MgF₂

- 85% reflectivity at LXe wavelengths
- Need ~ 100 nm thickness Al+ ~ 100 nm MgF₂ protective layer
- Radiopurity not very good – gets better with higher purity Al J. Radioanaly. and Nucl. Chem. (2019) 322:1447–1454

Material	U [uBq/kg]	Th [uBq/kg]	40K [uBq/kg]
DuPont TE-6472 (EXO-200)	< 10	< 1	56 (6)
DuPont NXT75 (EXO-200)	< 23	< 6.5	100 (30)
Amsler & Frey (XENONnT)	< 60	50 (20)	
DuPont NXT85 (LZ)	< 21	28 (4)	122 (1)

Material	U [uBq/kg]	Th [uBq/kg]	40K [uBq/kg]
Alfa Aesar 3N	3000 +/- 1200	110 +/- 47	
Materion 5N (nEXO)	900 +/- 500	2000 +/- 500	4000 +/- 2900
Al-LAURAND 6N	< 5.2	< 1.8	

Per unit surface area, Al (100 nm) contributes less background than PTFE UL (1 mm)!

Support Structures - Polymers

Plastics are often used for internal insulating components

PTFE, PCTFE, Acrylic, are great options if mechanical strength is not a requirement

For stronger material, engineered plastics such as **Ultem 1000** (PEI, polyetherimide) can be obtained at ~60 uBq/kg, ~30 uBq/kg Th of uranium and thorium

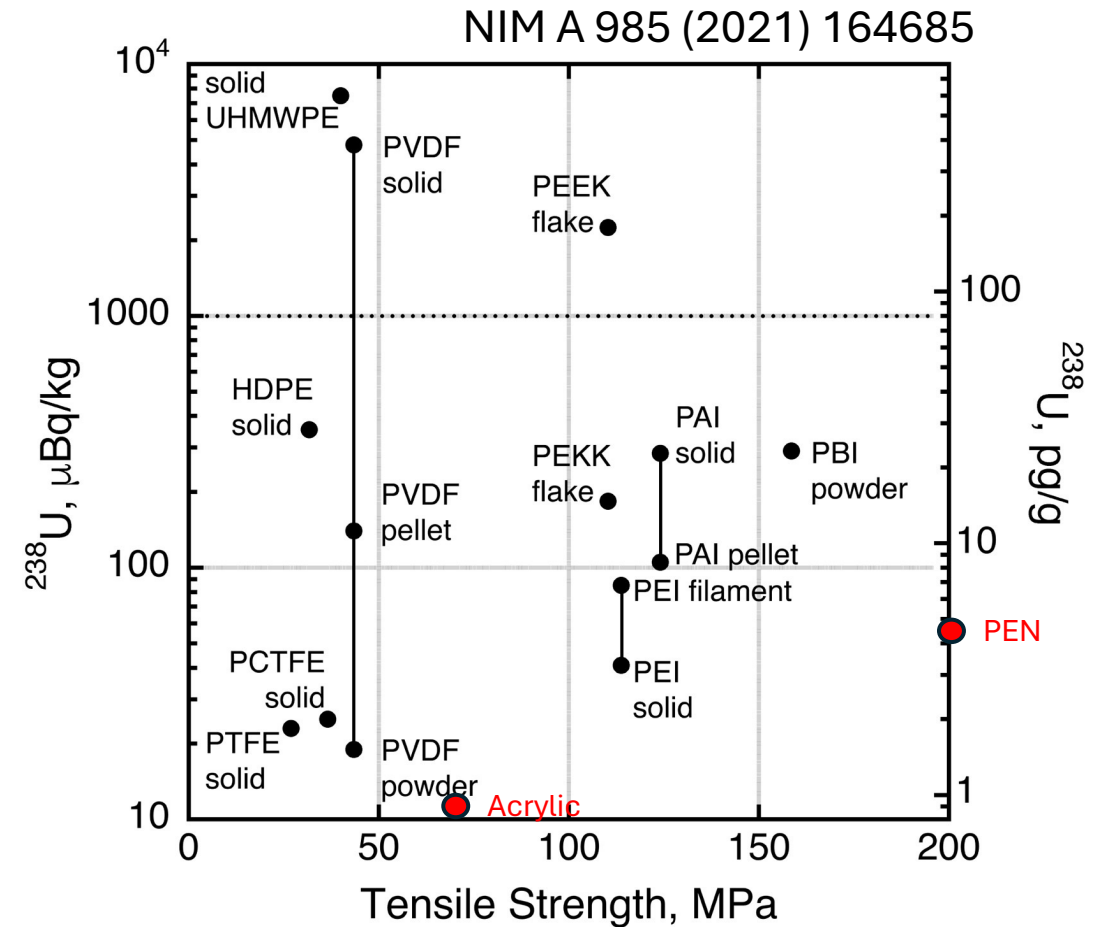
PEN, poly(ethylene naphthalate), is a strong scintillating plastic that can be used to self-veto activity with radiopurity of ~60 uBq/kg U, 30 uBq/kg Th

2022 JINST 17 C03031

Rules of Thumb:

Choose natural grades (unfilled, undyed)

Plastics can absorb water – bake if possible



ULTEM 1000



PEN

Support Structures

For insulating support structures fused silica is a good option, but not very strong under tension

Sapphire is extremely strong under both tension and compression (300-400 MPa tensile strength)

Hard to assay – but recent NAA + gamma coincidence method has shown that sapphire can be produced with radiopurity levels of $^{238}\text{U} < 28 \text{ uBq/kg}$, $^{232}\text{Th} < 1 \text{ uBq/kg}$

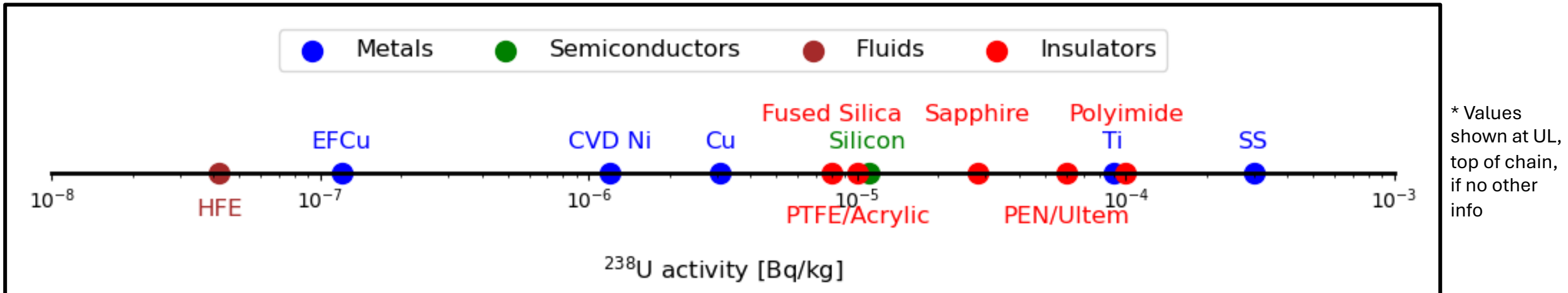
[arXiv:2508.04232](https://arxiv.org/abs/2508.04232)

PRC 10.1103/zgzm-w5f4



Supplier	Experiment	Assay method	Th [ppt]	U [ppt]	Ref.
Single Crystal Technology (Holland)	CRESST	NAA	< 33	< 40	[34]
Crystal Systems (USA)	CRESST	NAA	< 2.3	< 20	[34]
RSA (France)	ROSEBUD	Ge	< 1200	< 400	[3]
RSA (France)	ROSEBUD	Ge	< 500	< 160	[3]
Russia	ROSEBUD	Ge	< 1200	< 400	[3]
Swiss Jewel Company (USA)	EXO-200	NAA	30 ± 7	< 25	[35]
Marketech Intern. (Taiwan)	Majorana	NAA	< 21	< 300	[36]
Hamamatsu (Japan), for R11410-20	LZ	Ge	3500 ± 740	2800 ± 240	[37]
Hamamatsu (Japan), for R11410-30	XENON1T	Ge	1200 ± 310	3600 ± 200	[38]
Precision Sapphire Tech. (Lithuania)	nEXO	NAA	410 ± 41	990 ± 99	[39]
GTAT Corporation (USA), crackle	nEXO	Ge	< 1100	< 270	[39]
GTAT Corporation (USA)	nEXO	NAA	6.0 ± 1.1	< 8.9*	[39]
Saint Gobain (USA), alumina	nEXO	Ge	1800 ± 580	< 270	[39]
Saint Gobain (USA), alumina	nEXO	Ge	6500 ± 1100	2600 ± 520	[39]
Saint Gobain (USA)	nEXO	NAA	< 0.26	< 2.3	This work

Material Radiopurity Takeaways



- Material radiopurity should be kept in mind from the very beginning
 - Not going to reach 10^{28} yr sensitivity with radiopurity as an afterthought
- New radiopure materials are being identified all the time
 - CVD nickel, tungsten, sapphire, polyimide, PEN, etc...
- If commercial products are not radiopure enough, there is still hope
 - Work with vendors: PMTs, Radiopure cables, titanium, polyimide
 - Look at alternative fabrication techniques: CVD, crystal growth,
 - Make your own: Electroformed copper, PEN, etc.

Radiopurity Assay Results

- **Common need for all detector technologies**
 - Huge potential area for collaboration!
- Tends to be lower priority publication but is extremely important
- Suggest to share results on radiopurity.org

Pacific Northwest NATIONAL LABORATORY

radiopurity.org

SNO LAB

documentation
GitHub

about search advanced search insert update

Query Assistant

1 Bq U-238/kg	=	81 ppb U	(81 x 10 ⁻⁹ gU/g)
1 Bq Th-232/kg	=	246 ppb Th	(246 x 10 ⁻⁹ gTh/g)
1 Bq K-40/kg	=	32300 ppb K	(32300 x 10 ⁻⁶ gK/g)
1 Bq U-235/kg	=	1.76 ppm U	(1.76 x 10 ⁻⁶ gU/g)

Search for records containing the term...

☒ include synonyms

[advanced search](#)

EXO-200:

[NIM A591:490-509,2008](#)

[NIM A871:169-179, 2017](#)

nEXO:

[J. Phys. G: Nucl. Part. Phys. **49** 015104](#)

All measurements to be published soon

NEXT:

[2013 JINST 8 T01002](#)

[JHEP05\(2016\)159](#)

XENON1T:

[Eur. Phys. J. C \(2017\) 77:890](#)

XENONnT:

[Eur. Phys. J. C \(2022\) 82:599](#)

LUX:

[Astropart. Phys. 62 \(2015\) 33-46](#)

LZ:

[Eur. Phys. J. C \(2020\) 80:1044](#)

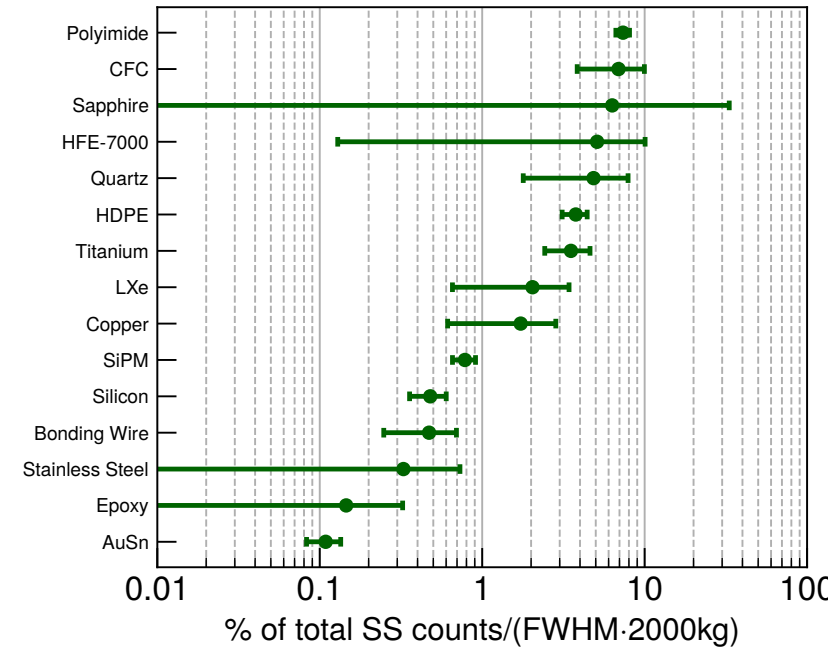
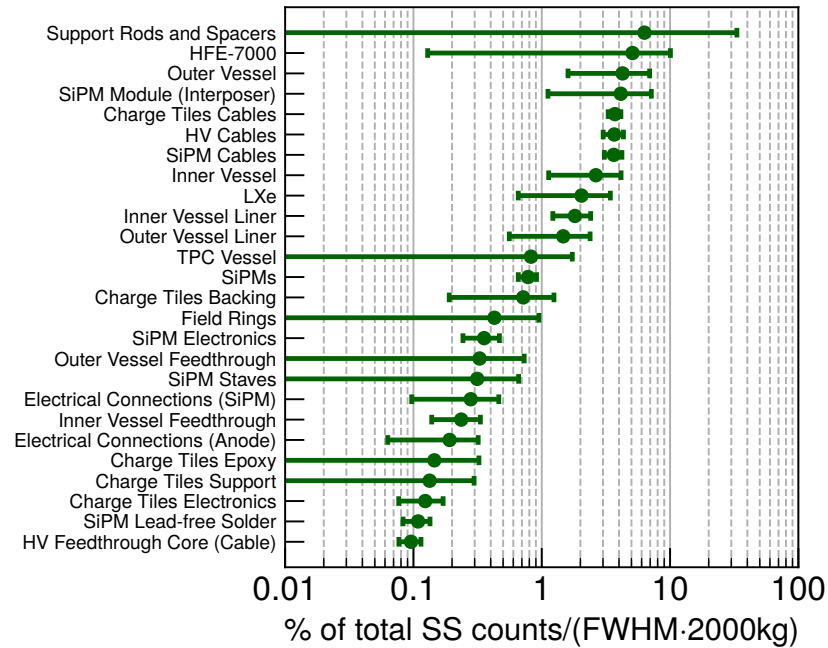
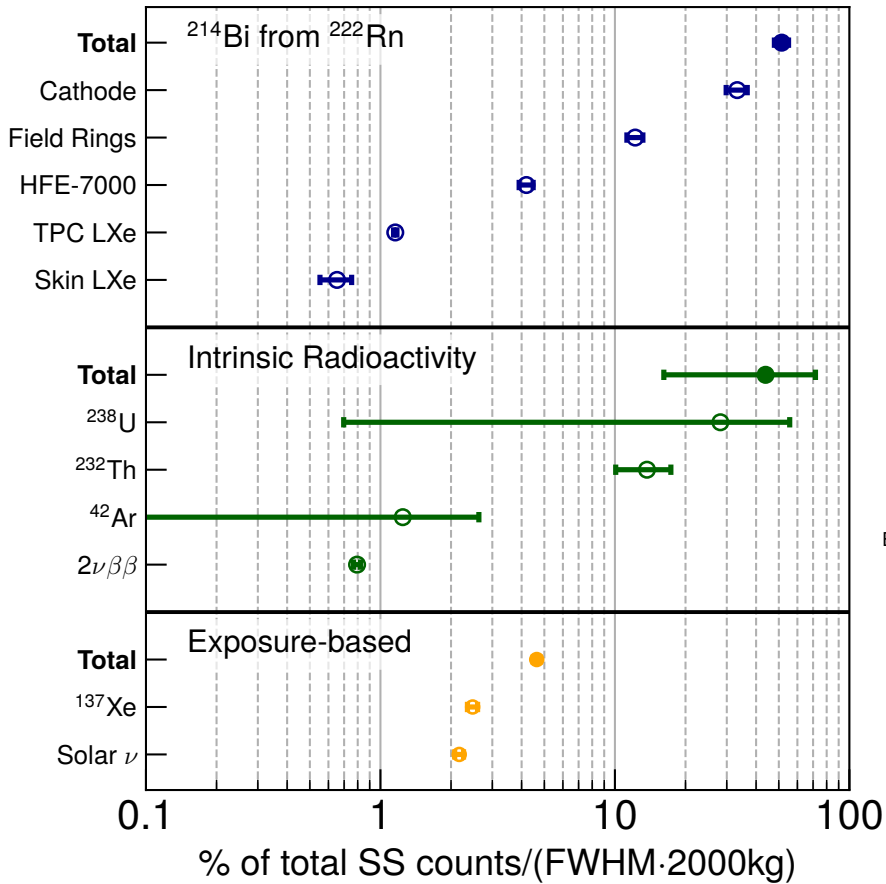
MAJORANA DEMONSTRATOR:

[NIM A828:22-36,2016](#)

and many more....

Thank You

nEXO Background Budget



nEXO: neutrinoless double beta decay search beyond 10^{28} year half-life sensitivity

2022 *J. Phys. G: Nucl. Part. Phys.* **49** 015104

NEXT-100 Background Budget

Detector subsystem	Material	Quantity	^{208}Tl (mBq)	^{214}Bi (mBq)
<i>Pressure vessel</i>				
Total	Steel 316Ti	1310 kg	< 197	< 603
<i>Energy plane</i>				
PMTs	R11410-10	60 units	11(3)	21(5)
PMT enclosures	Copper CuA1	60×4.3 kg	< 0.36	< 3.1
Enclosure windows	Sapphire	60×0.14 kg	0.34(8)	< 2.6
<i>Tracking plane</i>				
SiPMs	SENSL 1 mm ²	107×64 units	< 0.2	< 0.6
Boards	Kapton FPC	107 units	1.11(12)	7.5(5)
<i>Field cage</i>				
Barrel	Polyethylene	128 kg	< 1	< 8
Shaping rings	Copper CuA1	120×3 kg	< 0.5	< 4
Electrode rings	Steel 316Ti	2×5 kg	< 1.5	< 5
Anode plate	Fused silica	9.5 kg	0.32(4)	2.0(5)
Resistor chain	1-GΩ resistors	240 units	< 0.0026	< 0.02
<i>Shielding</i>				
Inner shield	Copper CuA1	9620 kg	< 13	< 120
Outer shield	Lead	60700 kg	2060(430)	21300(4300)

Table 3. Radioactivity budget of the NEXT-100 detector. The figures in parentheses after the measurements give the 1-sigma uncertainties in the last digits. The upper limits in the activity of most subsystems originate in the 95% CL limits set on the specific activity of the corresponding materials quoted on table 2.

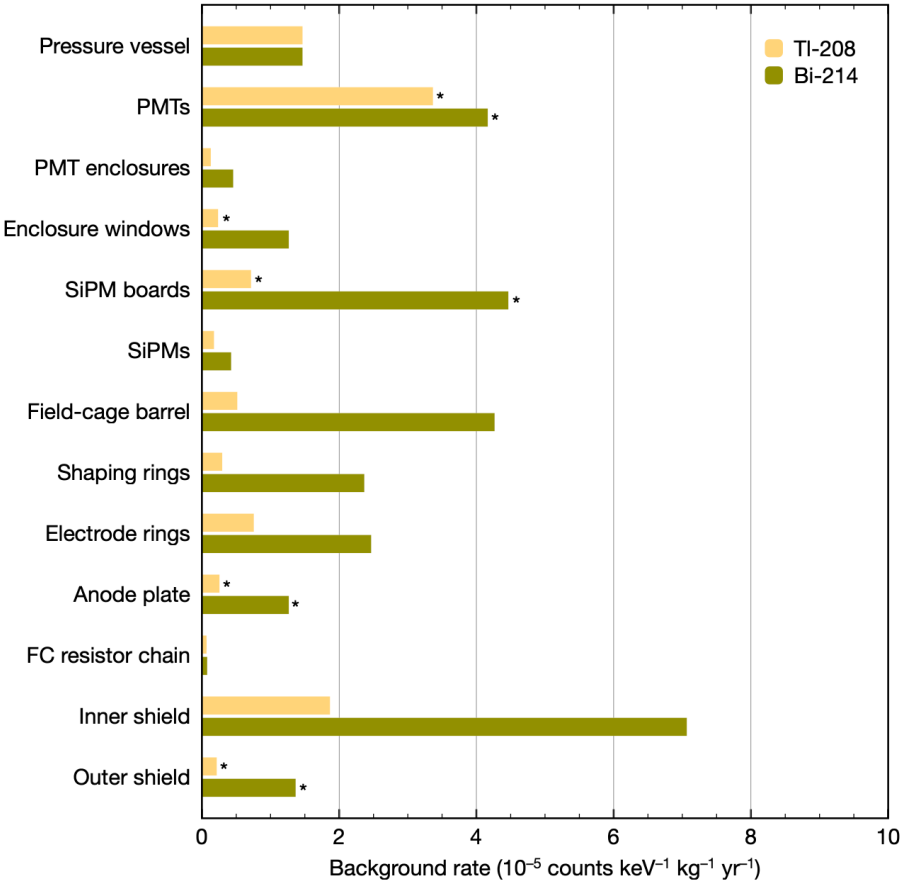


Figure 9. Contribution to the background rate of NEXT-100 of the different detector subsystems considered in our background model. An asterisk (*) next to a bar indicates that the contribution corresponds to a positive measurement of the activity of the material.

XLZD Background Budget

Component	²¹⁴ Bi events		
	LZ		XLZD (8.2 t × 10 years) Projected
	(967 kg × 1000 d)		
	Nominal	Reduced	
TPC PMTs	2.95	0.98	0.61
PMT structures	2.75	0.54	0.33
Field-cage resistors	2.46	0	0
Internal sensors	1.81	0.22	0.14
PMT bases	1.52	0.39	0.24
Cryostat	1.26	0.82	0.51
PMT cables	1.01	0.16	0.10
Field-cage rings	0.97	0.40	0.25
OD tank supports	0.73	0	0
OD foam	0.71	0	0
Skin PMTs	0.69	0.06	0.04
Other skin parts	0.68	0.05	0.03
Other components	3.56	1.42	0.88
Total	21.10	5.05	3.15

Table 1. Simulated background of single scatter events from ²¹⁴Bi 2448 keV γ -rays originating from the decay of ²³⁸U in detector materials in the LZ experiment. Listed are the highest contributors to the $0\nu\beta\beta$ search, with the corresponding expected number of events in the $\pm 1\sigma$ ROI (assuming 1.0% energy resolution) and in the 967 kg inner fiducial volume of LZ, for a 1000 live days run [11]. Smaller contributors grouped under ‘Other components’ are listed in the text. The third column shows the expected number of events after application of the mitigation strategies described in the text, resulting in an overall radioactivity reduction of approximately 75%. The fourth column shows the projected events in the 8.2 t fiducial volume of a 60 t XLZD (see section 4) in 10 years under this scenario.

PMT Components

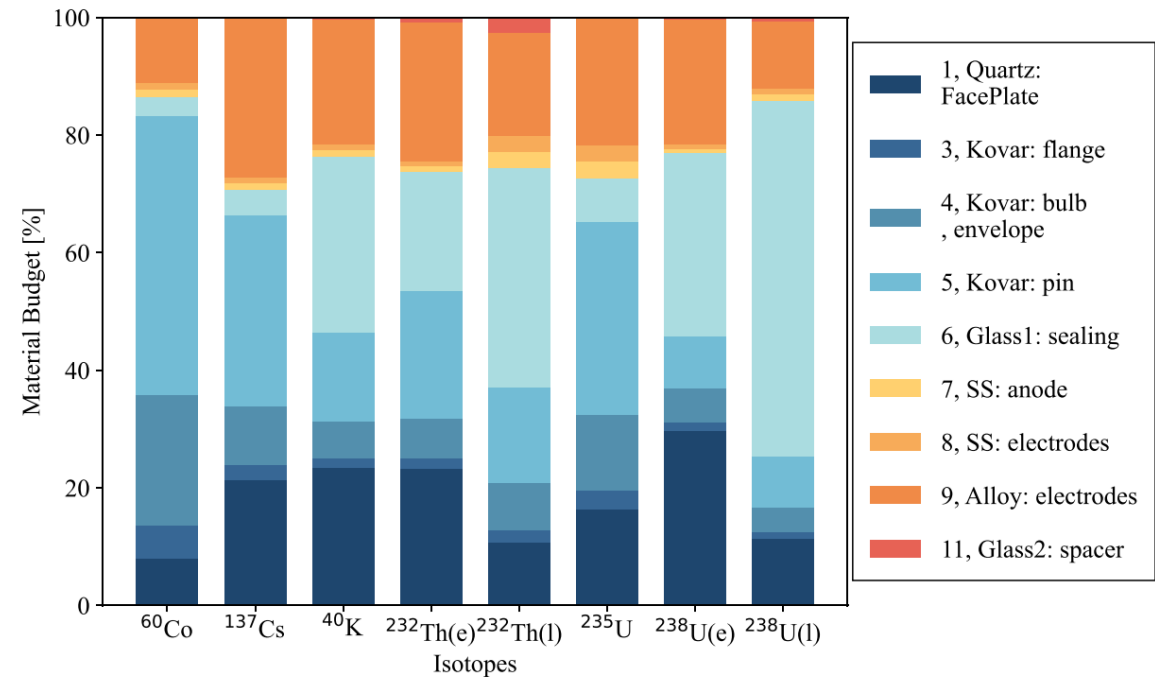
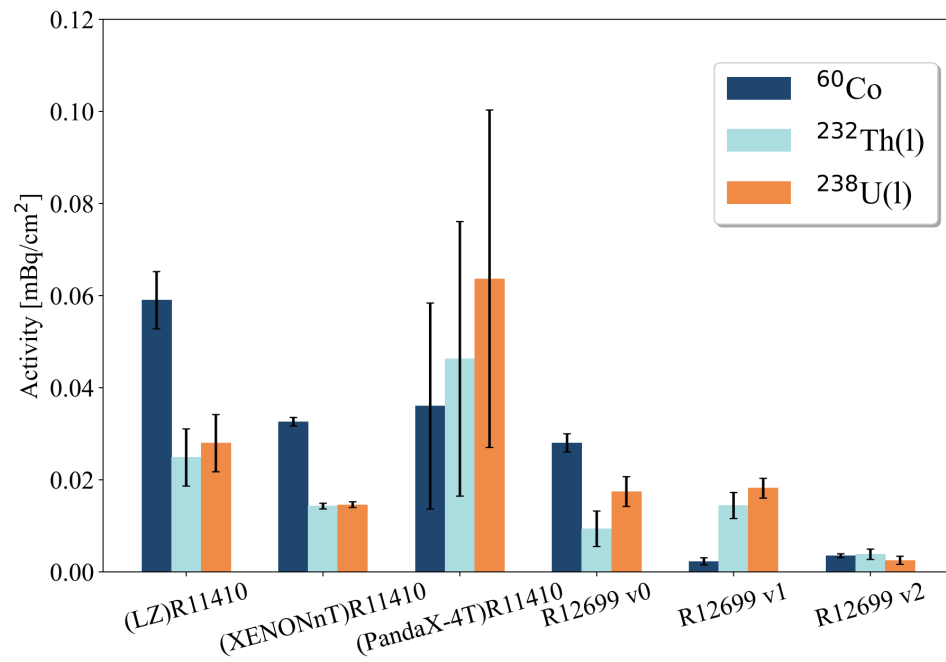


Fig. 4. The material radioactivity budget of R12699 PMT.